

SIGMAclad & SIGMAclad lite FOR ROUND CELLS & MORE



Improved conductivity? We have the solution for your cell connectors. SIGMAclad is perfect for large series (stamping and forming) as well as small series (produced by etching, wire EDM, laser, or water-jet cutting).

Advantages:

- > Significantly higher electrical conductivity than nickel
- > Very good joining options
- > Good punching and forming properties
- > Very good corrosion resistance



SIGMAclad Nickel

Stainless Steel Copper Stainless Steel Nickel



SIGMAclad lite

Stainless Steel Copper Stainless Steel

Compare the thermal runaway







SIGMAclad

PORTFOLIO WICKEDER GROUP

- > Clad Materials > Bimetals > Nickel Strips > Metal Foils
- > Photochemical Etching > Sheet Metal Working > Waterjet Cutting
- > Electroforming > Parylene Coating > Materials Engineering etc.

